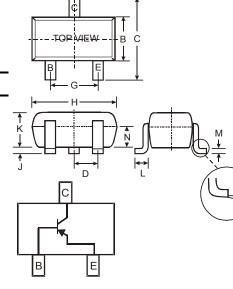


### Features

- Epitaxial Planar Die Construction •
- Complementary NPN Type Available (MMBT2222AT) •
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

## Mechanical Data

- Case: SOT-523 •
- Case Material: Molded Plastic. UL Flammability • Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over
- Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking Information: 2F, See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.002 grams (approximate)



١A

SOT-523										
Dim	Min	Max	Тур							
Α	0.15	0.30	0.22							
в	0.75	0.85	0.80							
С	1.45	1.75	1.60							
D			0.50							
G	0.90	1.10	1.00							
н	1.50	1.70	1.60							
J	0.00	0.10	0.05							
к	0.60	0.80	0.75							
L	0.10	0.30	0.22							
М	0.10	0.20	0.12							
Ν	0.45	0.65	0.50							
α	0°	8°								
All D	imens	ions in	mm							

# **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit		
Collector-Base Voltage		V <sub>CBO</sub>	-60	V		
Collector-Emitter Voltage		V <sub>CEO</sub>	-60	V		
Emitter-Base Voltage		V <sub>EBO</sub>	-5.0	V		
Collector Current - Continuous		Ι <sub>C</sub>	-600	mA		
Power Dissipation	(Note 1)	Pd	150	mW		
Thermal Resistance, Junction to Ambient	(Note 1)	$R_{ heta JA}$	833	°C/W		
Operating and Storage Temperature Range		T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C		

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

No purposefully added lead 2

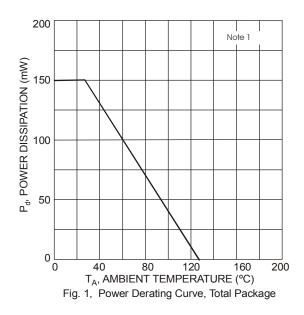
 Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

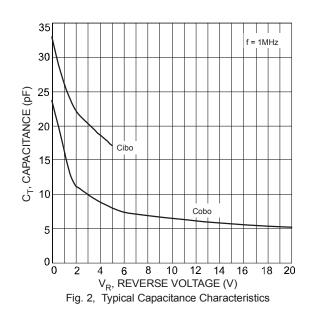


# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

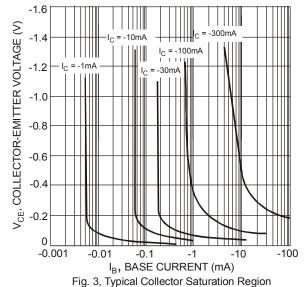
Characteristic	Symbol	Min	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 5)					1		
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-60	_	V	$I_{\rm C} = -10 \mu A, I_{\rm E} = 0$		
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-60	_	V	I <sub>C</sub> = -10mA, I <sub>B</sub> = 0		
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5.0	_	V	$I_{\rm E} = -10\mu A, I_{\rm C} = 0$		
Collector Cutoff Current	I <sub>CBO</sub>	_	-10	nA μA	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0 V <sub>CB</sub> = -50V, I <sub>E</sub> = 0, T <sub>A</sub> = 125°C		
Collector Cutoff Current	ICEX	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$		
Base Cutoff Current	I <sub>BL</sub>	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$		
ON CHARACTERISTICS (Note 5)							
DC Current Gain	hFE	75 100 100 100 50	  300 	_	$\begin{split} I_{C} &= -100 \mu A, \ V_{CE} &= -10V \\ I_{C} &= -1.0 m A, \ V_{CE} &= -10V \\ I_{C} &= -10 m A, \ V_{CE} &= -10V \\ I_{C} &= -150 m A, \ V_{CE} &= -10V \\ I_{C} &= -500 m A, \ V_{CE} &= -10V \end{split}$		
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	-0.4 -1.6	V	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>	_	-1.3 -2.6	v	I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA		
SMALL SIGNAL CHARACTERISTICS							
Output Capacitance	C <sub>obo</sub>		8.0	pF	$V_{CB}$ = -10V, f = 1.0MHz, I <sub>E</sub> = 0		
Input Capacitance	C <sub>ibo</sub>	_	30	pF	$V_{EB}$ = -2.0V, f = 1.0MHz, I <sub>C</sub> = 0		
Current Gain-Bandwidth Product	fT	200	—	MHz	V <sub>CE</sub> = -20V, I <sub>C</sub> = -50mA, f = 100MHz		
SWITCHING CHARACTERISTICS							
Turn-On Time	t <sub>off</sub>		45	ns			
Delay Time	t <sub>d</sub>		10	ns	V <sub>CC</sub> = -30V, I <sub>C</sub> = -150mA, I <sub>B1</sub> = -15mA		
Rise Time	tr	_	40	ns			
Turn-Off Time	t <sub>off</sub>	_	100	ns			
Storage Time	ts	_	80	ns	V <sub>CC</sub> = -6.0V, I <sub>C</sub> = -150mA, I <sub>B1</sub> = I <sub>B2</sub> = -15mA		
Fall Time	t <sub>f</sub>	_	30	ns			

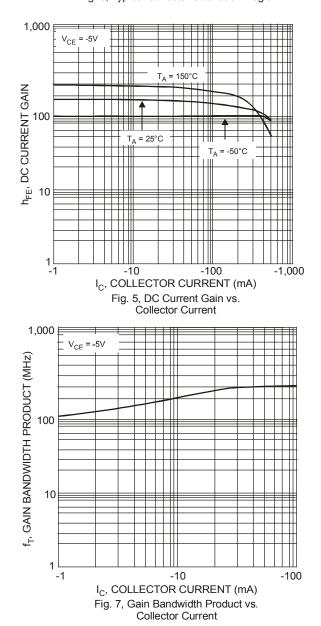
Notes: 5. Short duration pulse test used to minimize self-heating effect.

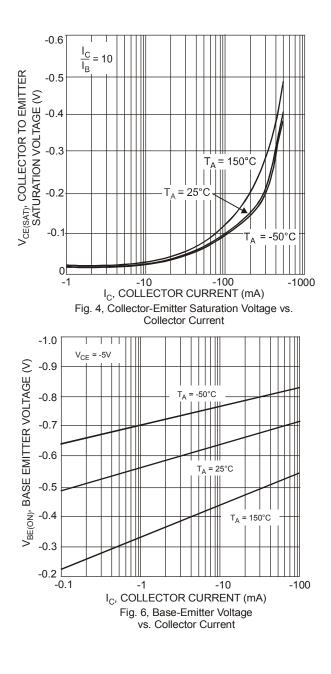












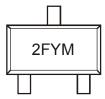


### Ordering Information (Note 6)

Device	Packaging	Shipping
MMBT2907AT-7-F	SOT-523	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



2F = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key															
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	К	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z

Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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